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**ON Semiconductor®** 

## FQD2N60C / FQU2N60C N-Channel QFET<sup>®</sup> MOSFET 600 V, 1.9 A, 4.7 Ω

## Features

- + 1.9 A, 600 V,  $R_{DS(on)}$  = 4.7  $\Omega$  (Max.) @ V\_{GS} = 10 V,  $I_{D}$  = 0.95 A
- Low Gate Charge (Typ. 8.5 nC)
- Low Crss (Typ. 4.3 pF)
- 100% Avalanche Tested
- RoHS Compliant

## Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.



## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQD2N60CTM / FQU2N60CTU	Unit
V <sub>DSS</sub>	Drain-Source Voltage		600	V
ID	Drain Current - Continuous ( $T_c = 25^{\circ}C$ )		1.9	А
	- Continuous (T <sub>C</sub> = 100°C)		1.14	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	7.6	А
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy		120	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	1.9	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	4.4	mJ
dv/dt	Peak Diode Recovery dv/dt (No		4.5	V/ns
	Power Dissipation (T <sub>A</sub> = 25°C)*		2.5	W
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25°C)		44	W
	- Derate above 25°C		0.35	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes,		300	°C
	1/8" from case for 5 seconds			5

## **Thermal Characteristics**

Symbol	Parameter	FQD2N60CTM / FQU2N60CTU	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.87	°C/W
P	Thermal Resistance, Junction-to-Ambient (minimum pad of 2 oz copper), Max.	110	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (* 1 in <sup>2</sup> pad of 2 oz copper), Max.	50	

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FQD2N60C	FQD2N60CTM	D-PAK	330 mm	16 mm	2500 units
FQU2N60C	FQU2N60CTU	I-PAK	Tube	N/A	70 units

## **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	aracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	600			V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		0.6		V/°C
	7 0 1 1/1 5 1 0 1	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V			1	μA
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 480 V, T <sub>C</sub> = 125°C			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
On Cha	aracteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.95 A		3.6	4.7	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 0.95 A		5.0		S
Dynam <sub>Ciss</sub>	ic Characteristics	V - 25 V V - 0 V		180	235	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz		20	25	p. pF
C <sub>rss</sub>	Reverse Transfer Capacitance	4		4.3	5.6	pF
	ing Characteristics			1		
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 2 \text{ A},$		9	28	ns
t <sub>r</sub>	Turn-On Rise Time	$R_{G} = 25 \Omega$		25	60	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			24	58	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		28	66	ns
Qg	Total Gate Charge	$V_{DS} = 480 \text{ V}, \text{ I}_{D} = 2 \text{ A},$		8.5	12	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V		1.3		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4)		4.1		nC
Drain-S	Source Diode Characteristics ar	nd Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source Dic				1.9	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode F	orward Current			7.6	A

IS	Maximum Continuous Drain-Source Diode Forward Current				1.9	
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				7.6	
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.9 A			1.4	
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS}$ = 0 V, I <sub>S</sub> = 2 A,		230		
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/µs		1.0		

NOTES:

1. Repetitive Rating : Pulse width limited by maximum junction temperature.

2. L = 56 mH, I\_{AS} = 2 A, V\_{DD} = 50 V, R\_G = 25  $\Omega,$  starting  $\mbox{ T}_{J}$  = 25°C.

3. I\_{SD} \leq 2 A, di/dt  $\leq$  200 A/µs, V\_{DD}  $\leq$  BV\_{DSS,} starting ~ T\_J = 25°C.

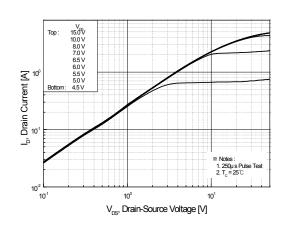
4. Essentially independent of operating temperature.

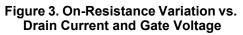
V ns μC

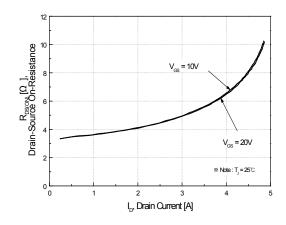
# Typical Performance Characteristics

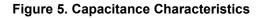
## Figure 1. On-Region Characteristics

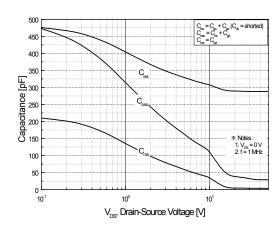
## Figure 2. Transfer Characteristics

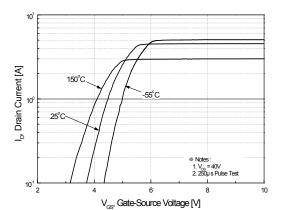




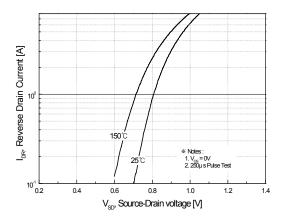




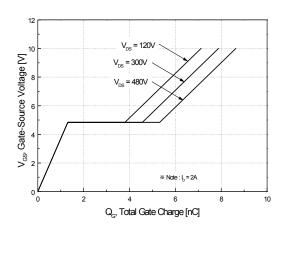


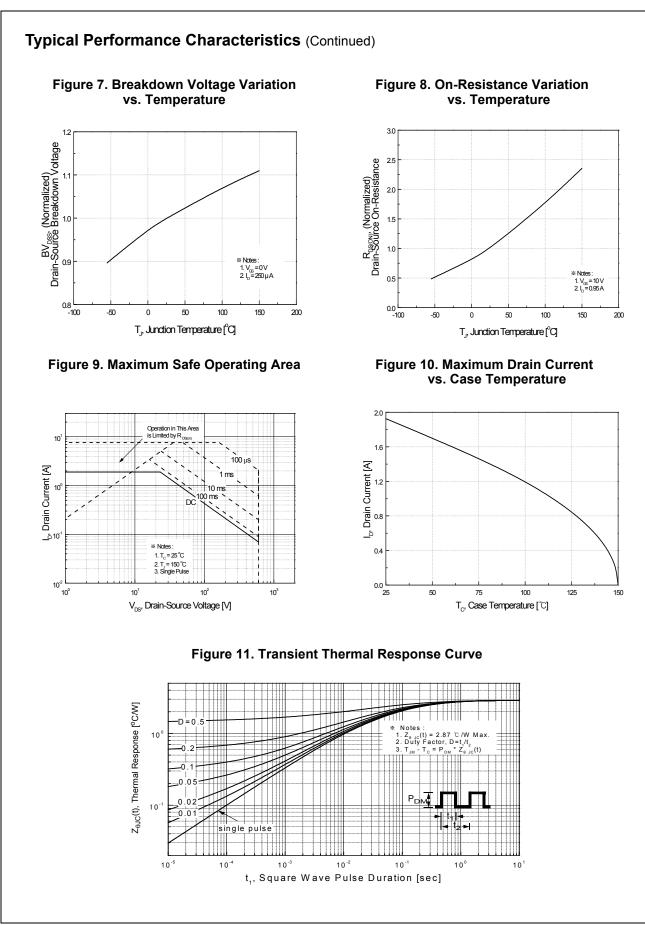


## Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

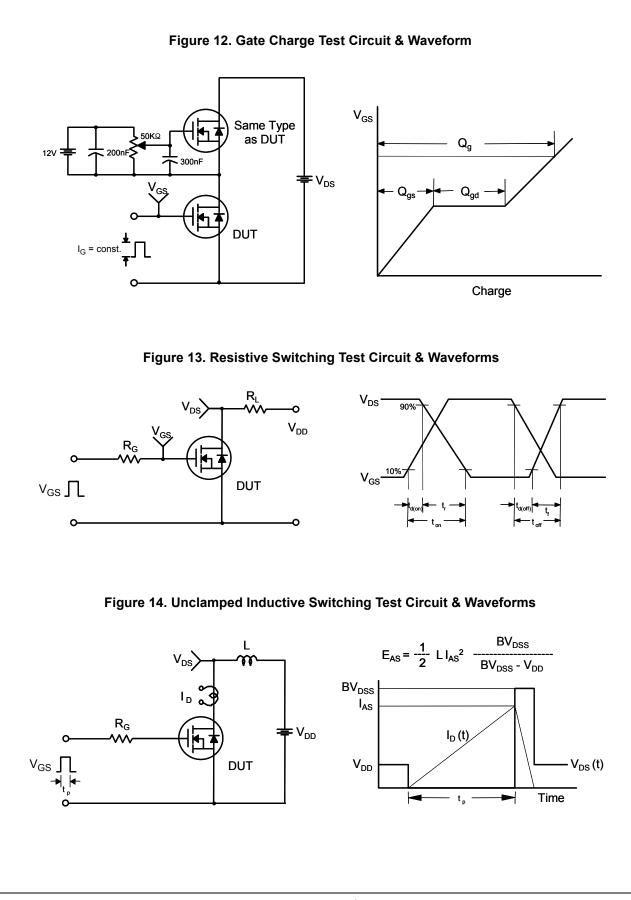








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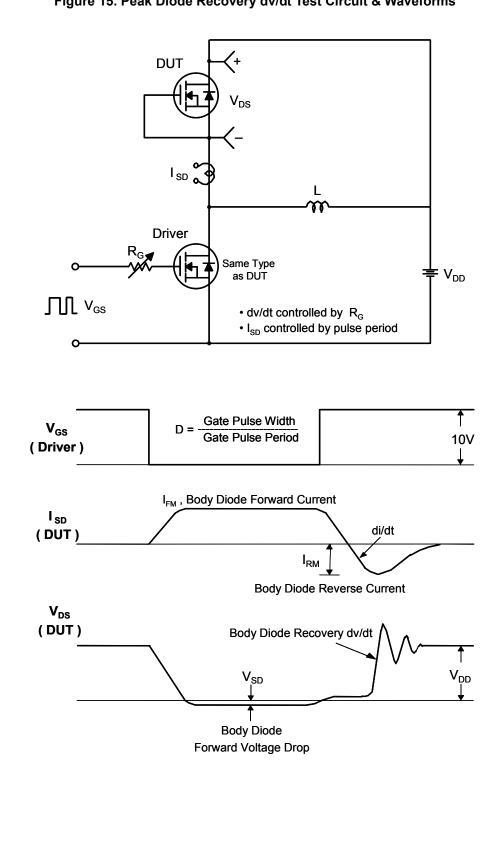


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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